



Vincotech

10-PY07NIA150S504-L365F54Y

datasheet

flowNPC 1

1200 V / 150 A

Features

- NPC inverter topology
- Optimized for full rated bi-directional usage (4 quadrant)
- Optimized for 1200 Vdc applications
- High-speed IGBT in all switch positions
- Integrated NTC
- Low inductive design with integrated DC capacitor
- flow 1 12mm package

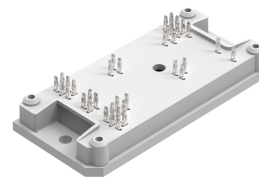
Target applications

- Energy Storage Systems
- Solar Inverters
- UPS

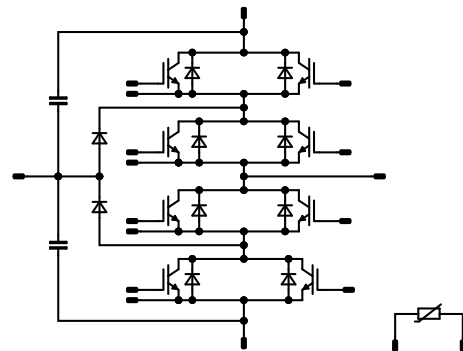
Types

- 10-PY07NIA150S504-L365F54Y

flow 1 12 mm housing



Schematic





Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------|--------|------------|-------|------|
|-----------|--------|------------|-------|------|

Buck Switch

| | | | | |
|-----------------------------------|------------|---------------------------------------|----------|----|
| Collector-emitter voltage | V_{CES} | | 650 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 105 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 450 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 145 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Buck Diode

| | | | | |
|---------------------------------|------------|---------------------------------------|-----|----|
| Peak repetitive reverse voltage | V_{RRM} | | 650 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 101 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 300 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 127 | W |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Boost Switch

| | | | | |
|-----------------------------------|------------|---------------------------------------|----------|----|
| Collector-emitter voltage | V_{CES} | | 650 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 105 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 450 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 145 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | °C |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|---------------------------------|------------|---------------------------------------|-------|------|
| Boost Diode | | | | |
| Peak repetitive reverse voltage | V_{RRM} | | 650 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 101 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 300 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 127 | W |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Boost Sw. Inv. Diode

| | | | | |
|---------------------------------|------------|---------------------------------------|-----|----|
| Peak repetitive reverse voltage | V_{RRM} | | 650 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 108 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 300 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 149 | W |
| Maximum junction temperature | T_{jmax} | | 175 | °C |

Capacitor (DC)

| | | | | |
|-----------------------|-----------|--|-------------|----|
| Maximum DC voltage | V_{MAX} | | 630 | V |
| Operation Temperature | T_{op} | | -55 ... 125 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{jop} | | -40...+($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|------------|-------------------------------------|-------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 6000 | V |
| Isolation voltage | V_{isol} | AC Voltage $t_p = 1\text{ min}$ | 2500 | V |
| Creepage distance | | | >12,7 | mm |
| Clearance | | | 7,86 | mm |
| Comparative Tracking Index | CTI | | ≥ 200 | |

*100 % tested in production



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Buck Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|--------------------------|----|-----|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0015 | 25 | 3,2 | 4 | 4,8 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 150 | 25 125 150 | | 1,43 1,52 1,55 | 1,75 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 650 | | 25 | | | 100 | µA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{ies} | $f = 1 \text{ Mhz}$ | 0 | 25 | | 25 | | 9000 | | pF |
| Output capacitance | C_{oes} | | | | | | | 260 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 34 | | pF |
| Gate charge | Q_g | $V_{CC} = 520 \text{ V}$ | 15 | | 150 | 25 | | 328 | | nC |

Thermal

| | | | | | | | | | | |
|--|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX) | | | | | | 0,65 | | K/W |
|--|---------------|---|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|---|-------|-----|----|------------------|--|-------------------------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$ | -5/15 | 350 | 90 | 25 125 150 | | 47,8 50 49,4 | | ns |
| Rise time | t_r | | | | | 25 125 150 | | 8,6 10 10,4 | | ns |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 125 150 | | 147 170 176,4 | | ns |
| Fall time | t_f | | | | | 25 125 150 | | 10,58 19,16 22,34 | | ns |
| Turn-on energy (per pulse) | E_{on} | | | | | 25 125 150 | | 0,346 0,608 0,705 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 125 150 | | 1,07 1,56 1,74 | | mWs |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Buck Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|---------------|--|--|-----|------------------|--|----------------------|---------------------|----|
| Forward voltage | V_F | | | | 150 | 25 125 150 | | 1,53 1,49 1,47 | 1,92 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_i = 650$ V | | | | 25 | | | 7,6 | µA |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,75 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|---|-------|-----|----|------------------|--|----------------------------|--|------|
| Peak recovery current | I_{RRM} | $di/dt=7165$ A/µs $di/dt=8521$ A/µs $di/dt=7698$ A/µs | -5/15 | 350 | 90 | 25 125 150 | | 123,93 158,19 167,21 | | A |
| Reverse recovery time | t_{rr} | | | | | 25 125 150 | | 43,67 73,66 84,84 | | ns |
| Recovered charge | Q_r | | | | | 25 125 150 | | 3,35 6,78 7,78 | | µC |
| Reverse recovered energy | E_{rec} | | | | | 25 125 150 | | 0,87 1,72 1,92 | | mWs |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | | | | 25 125 150 | | 3889 3024 3127 | | A/µs |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Boost Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|--------------------------|----|-----|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0015 | 25 | 3,2 | 4 | 4,8 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 150 | 25 125 150 | | 1,43 1,52 1,55 | 1,75 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 650 | | 25 | | | 100 | µA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{ies} | $f = 1 \text{ Mhz}$ | 0 | 25 | | 25 | | 9000 | | pF |
| Output capacitance | C_{oes} | | | | | | | 260 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 34 | | pF |
| Gate charge | Q_g | $V_{CC} = 520 \text{ V}$ | 15 | | 150 | 25 | | 328 | | nC |

Thermal

| | | | | | | | | | | |
|--|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX) | | | | | | 0,65 | | K/W |
|--|---------------|---|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|---|-------|-----|----|------------------|--|-------------------------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$ | -5/15 | 350 | 90 | 25 125 150 | | 52,4 51,6 51,8 | | ns |
| Rise time | t_r | | | | | 25 125 150 | | 9,6 11 11,4 | | ns |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 125 150 | | 130,8 153,2 160 | | ns |
| Fall time | t_f | | | | | 25 125 150 | | 13,31 19,35 22,14 | | ns |
| Turn-on energy (per pulse) | E_{on} | | | | | 25 125 150 | | 0,666 1,23 1,39 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 125 150 | | 1,14 1,68 1,86 | | mWs |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|--|--------|-----|-----|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | | Min | Typ | Max | |

Boost Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|---------------|--|-----|------------------|--|--|----------------------|---------------------|----|
| Forward voltage | V_F | | | 150 | 25 125 150 | | | 1,53 1,49 1,47 | 1,92 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_i = 650$ V | | | 25 | | | | 7,6 | µA |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,75 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|---|-------|-----|----|------------------|--|----------------------------|--|------|
| Peak recovery current | I_{RRM} | $di/dt=9576$ A/µs $di/dt=6720$ A/µs $di/dt=7333$ A/µs | -5/15 | 350 | 90 | 25 125 150 | | 101,45 127,39 133,06 | | A |
| Reverse recovery time | t_{rr} | | | | | 25 125 150 | | 54,35 88,39 100,89 | | ns |
| Recovered charge | Q_r | | | | | 25 125 150 | | 3,47 6,78 7,84 | | µC |
| Reverse recovered energy | E_{rec} | | | | | 25 125 150 | | 0,807 1,47 1,67 | | mWs |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | | | | 25 125 150 | | 2283 1335 1270 | | A/µs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Boost Sw. Inv. Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|---------------|--|--|-----|------------------|------|----------------------|---------------------|----|
| Forward voltage | V_F | | | | 150 | 25 125 150 | 1,18 | 1,66 1,61 1,59 | 1,82 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_i = 650$ V | | | | 25 | | | 1,8 | µA |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,64 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Capacitor (DC)

Static

| | | | | | | | | | | |
|-------------|-----|--------------------------|--|--|--|----|-----|-----|----|----|
| Capacitance | C | DC bias voltage = 0 V | | | | 25 | | 200 | | nF |
| Tolerance | | | | | | | -10 | | 10 | % |

Thermistor

Static

| | | | | | | | | | | |
|--------------------------------|----------------|--------------------|--|--|--|-----|----|------|---|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R_{100} | $\Delta_{R/R}$ | $R_{100} = 1484$ Ω | | | | 100 | -5 | | 5 | % |
| Power dissipation | P | | | | | | | 5 | | mW |
| Power dissipation constant | d | | | | | 25 | | 1,5 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. ± 1 % | | | | | | 3962 | | K |
| B-value | $B_{(25/100)}$ | Tol. ± 1 % | | | | | | 4000 | | K |
| Vincotech Thermistor Reference | | | | | | | | | I | |

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

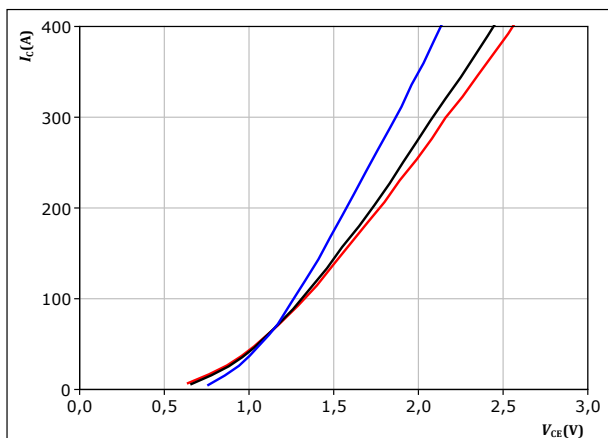
Buck Switch Characteristics

figure 1.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



$t_p = 250 \mu s$
 $V_{GE} = 15 V$

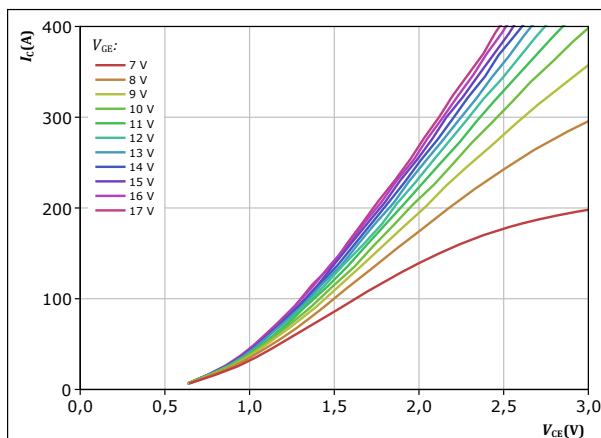
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 2.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



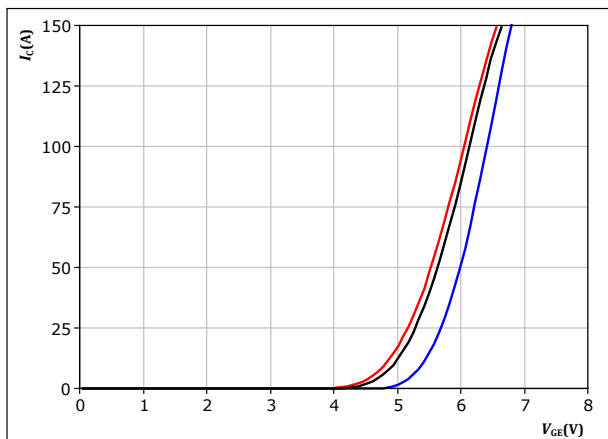
$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3.

IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



$t_p = 250 \mu s$
 $V_{CE} = 10 V$

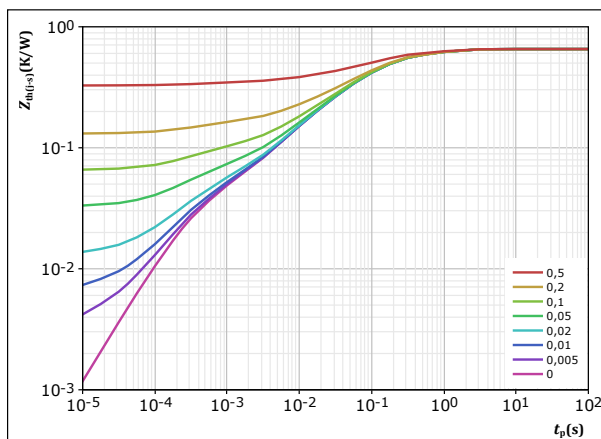
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 4.

IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,654 K/W$
IGBT thermal model values

| $R (K/W)$ | $\tau (s)$ |
|-----------|------------|
| 1,13E-01 | 8,46E-01 |
| 2,91E-01 | 1,23E-01 |
| 1,38E-01 | 3,33E-02 |
| 6,68E-02 | 8,32E-03 |
| 1,32E-02 | 2,63E-03 |
| 3,21E-02 | 3,23E-04 |



Vincotech

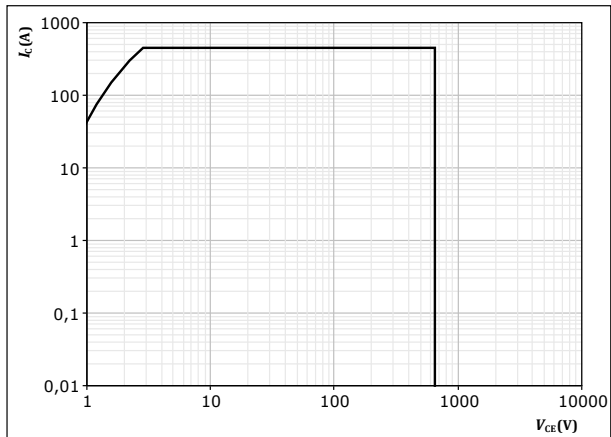
10-PY07NIA150S504-L365F54Y
datasheet

Buck Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D = \text{single pulse}$

$T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
 $T_j = T_{jmax}$



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

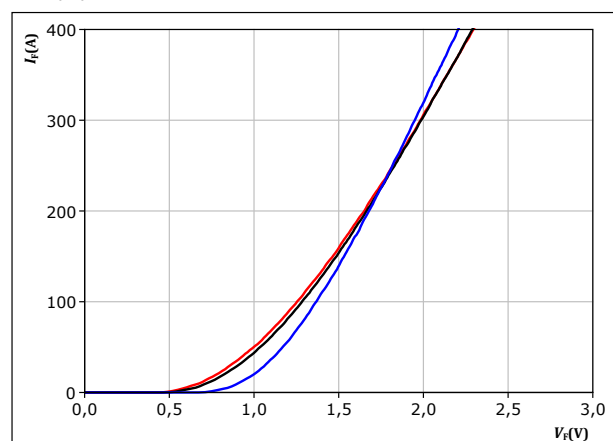
Buck Diode Characteristics

figure 6.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

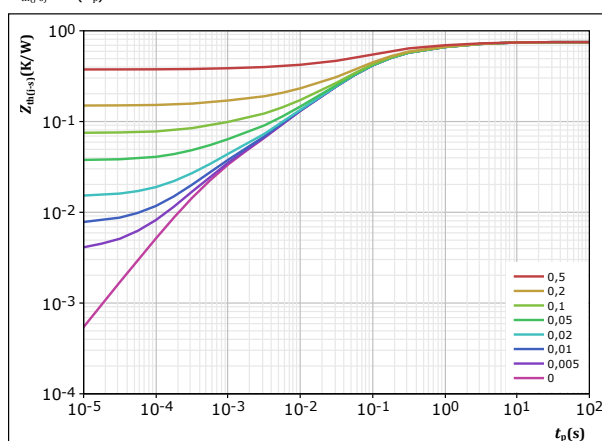
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 7.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,75 \text{ K/W}$
FWD thermal model values

| $R \text{ (K/W)}$ | $\tau \text{ (s)}$ |
|-------------------|--------------------|
| 6,17E-02 | 4,36E+00 |
| 1,22E-01 | 8,59E-01 |
| 2,77E-01 | 1,50E-01 |
| 2,01E-01 | 4,63E-02 |
| 6,55E-02 | 6,81E-03 |
| 2,23E-02 | 5,75E-04 |



Vincotech

10-PY07NIA150S504-L365F54Y datasheet

Boost Switch Characteristics

figure 8.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

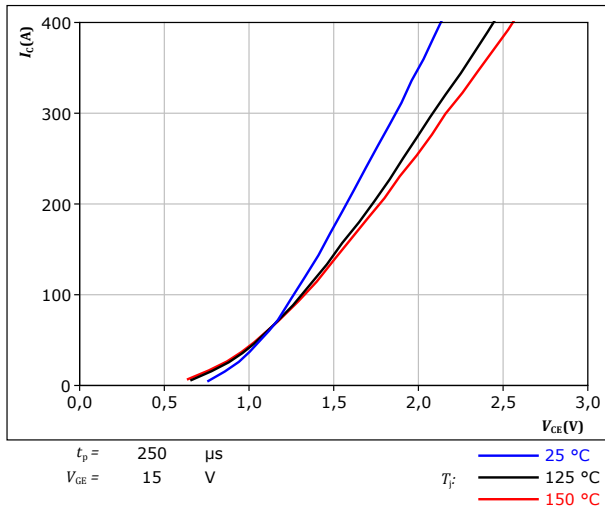


figure 9.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

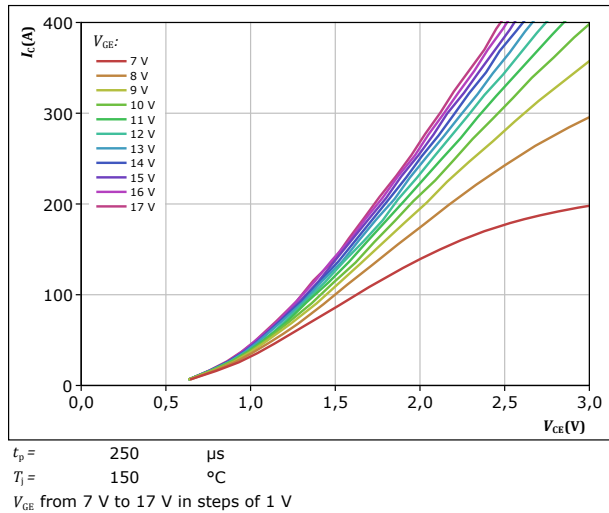


figure 10.

IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

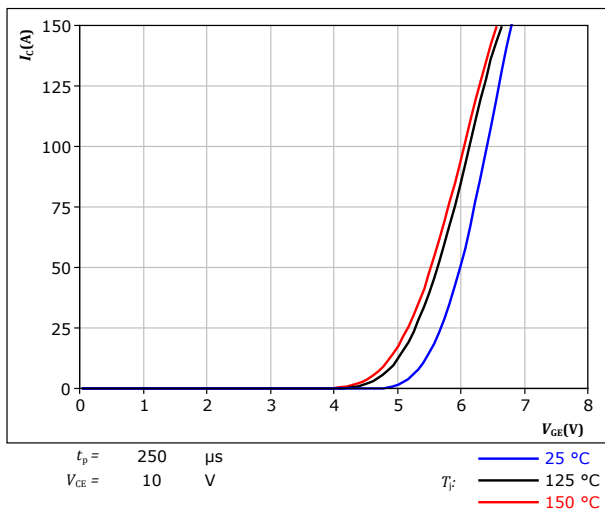
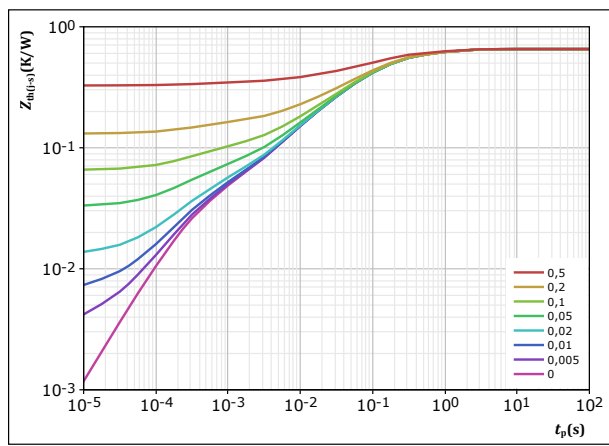


figure 11.

IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

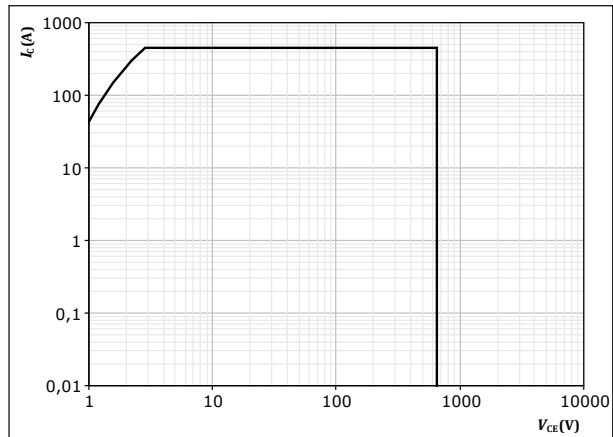
Boost Switch Characteristics

figure 12.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D = \text{single pulse}$

$T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
 $T_j = T_{jmax}$



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

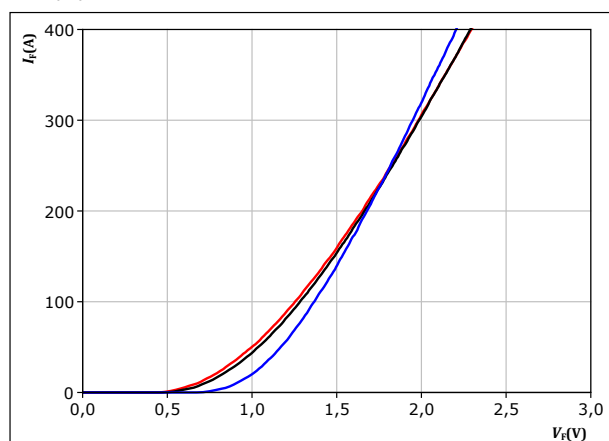
Boost Diode Characteristics

figure 13.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

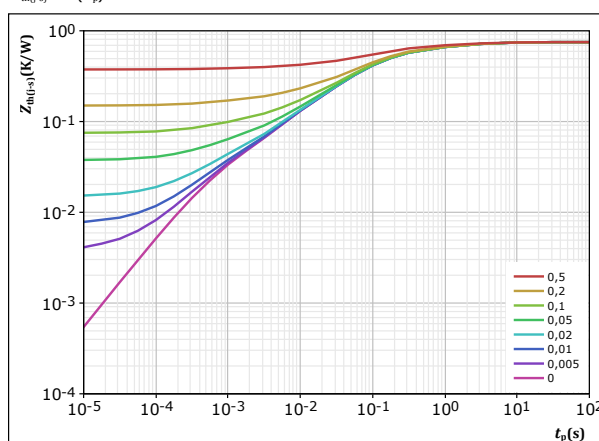
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 14.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,75 \text{ K/W}$
FWD thermal model values

| $R \text{ (K/W)}$ | $\tau \text{ (s)}$ |
|-------------------|--------------------|
| 6,17E-02 | 4,36E+00 |
| 1,22E-01 | 8,59E-01 |
| 2,77E-01 | 1,50E-01 |
| 2,01E-01 | 4,63E-02 |
| 6,55E-02 | 6,81E-03 |
| 2,23E-02 | 5,75E-04 |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

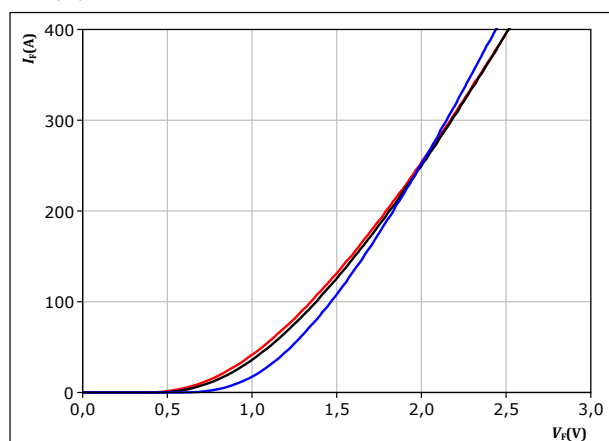
Boost Sw. Inv. Diode Characteristics

figure 15.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

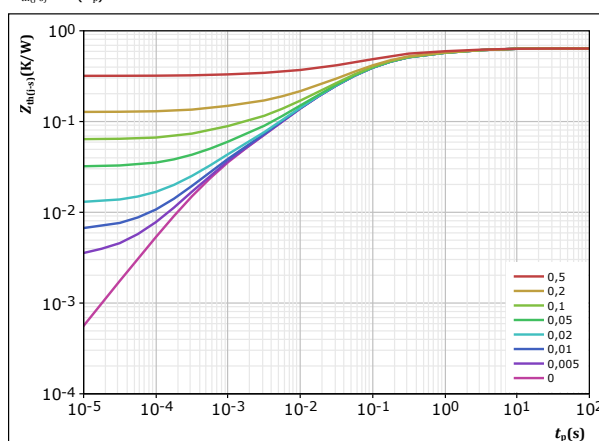
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 16.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



| | |
|--------------------------|------------|
| $D =$ | t_p / T |
| $R_{th(j-s)} =$ | 0,638 K/W |
| FWD thermal model values | |
| R (K/W) | τ (s) |
| 6,14E-02 | 3,48E+00 |
| 1,03E-01 | 5,85E-01 |
| 2,81E-01 | 9,46E-02 |
| 1,21E-01 | 2,14E-02 |
| 4,83E-02 | 5,07E-03 |
| 2,26E-02 | 5,92E-04 |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

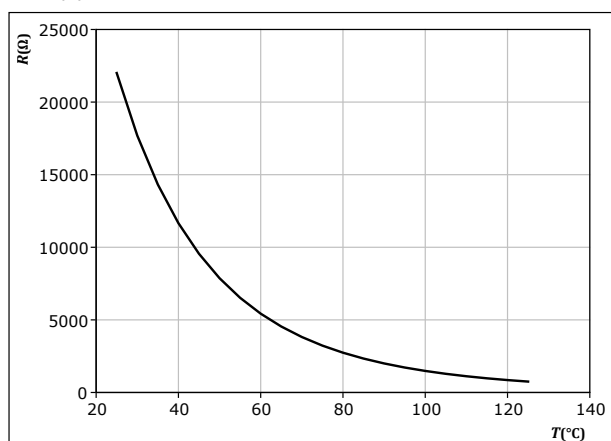
Thermistor Characteristics

figure 17.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

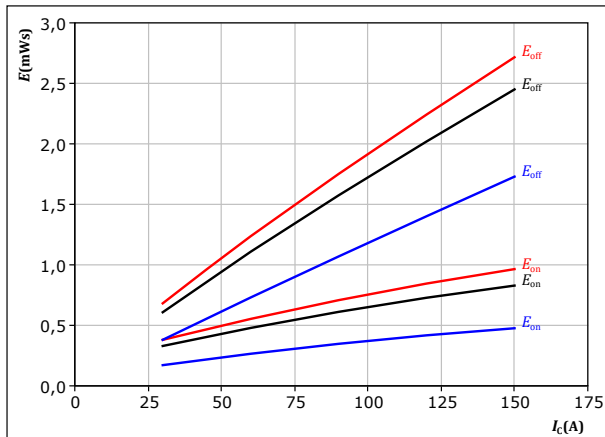
Buck Switching Characteristics

figure 18.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = -5/15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$
 $R_{goff} = 2 \text{ } \Omega$

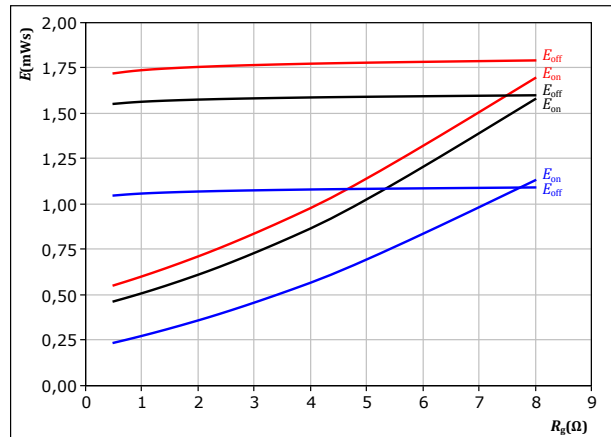
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 19.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = -5/15 \text{ V}$
 $I_C = 90 \text{ A}$

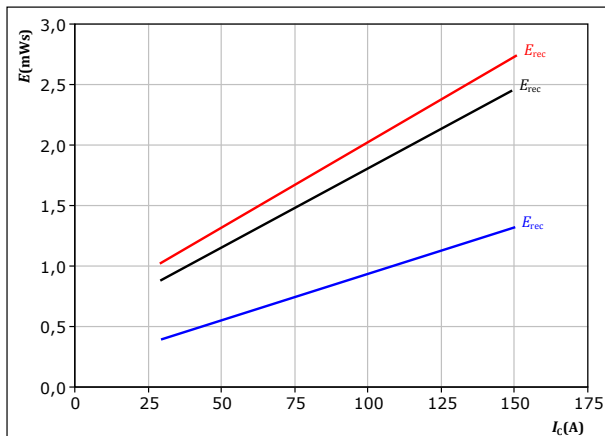
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 20.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = -5/15 \text{ V}$
 $R_{gon} = 2 \text{ } \Omega$

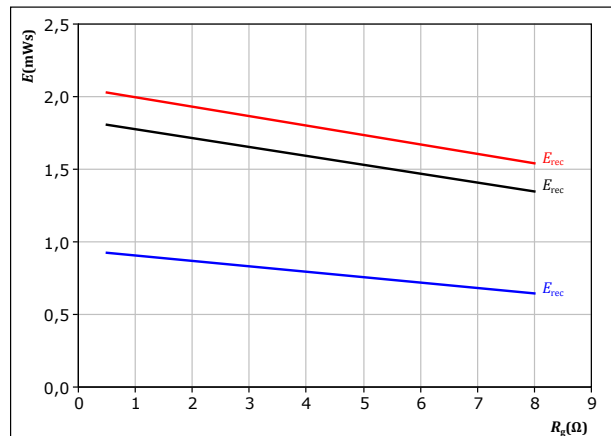
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 21.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = -5/15 \text{ V}$
 $I_C = 90 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

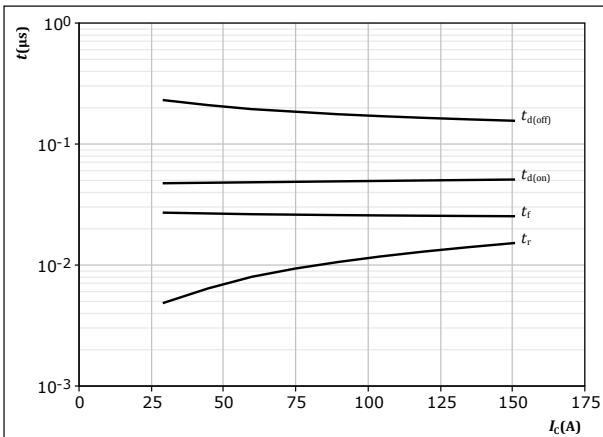
10-PY07NIA150S504-L365F54Y
datasheet

Buck Switching Characteristics

figure 22.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



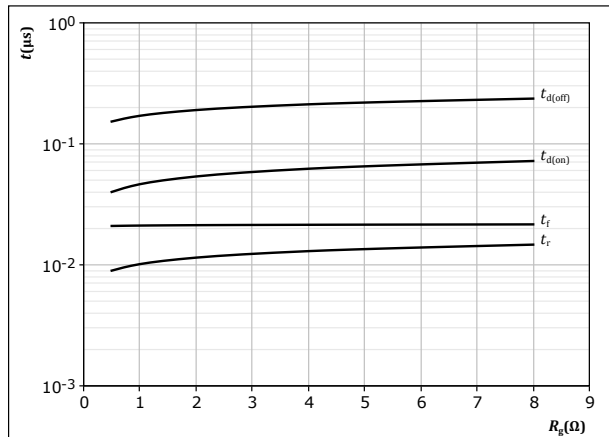
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 23.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



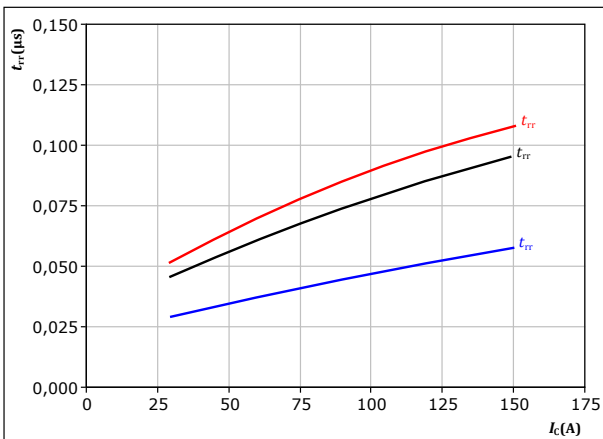
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

figure 24.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

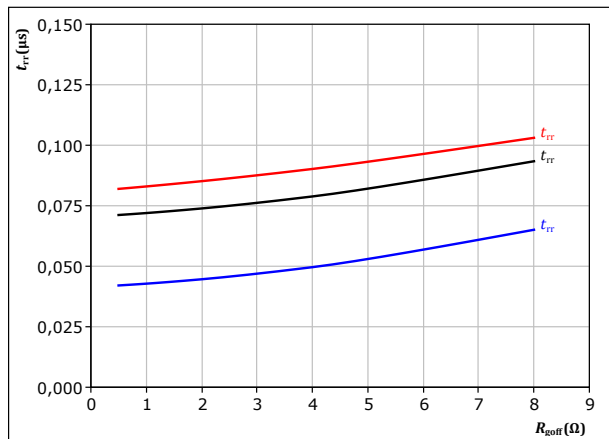
$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 25.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

T_j : — 25 °C
— 125 °C
— 150 °C



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

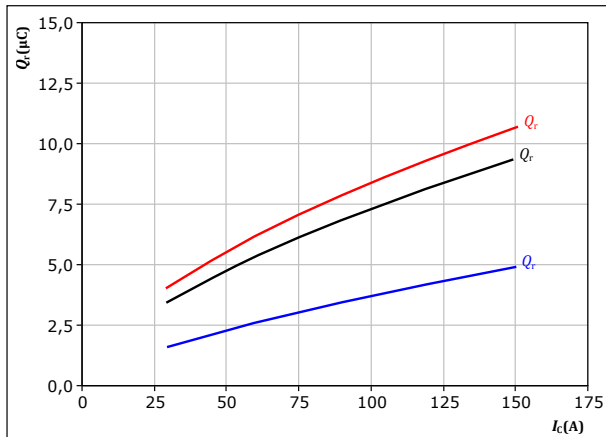
Buck Switching Characteristics

figure 26.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

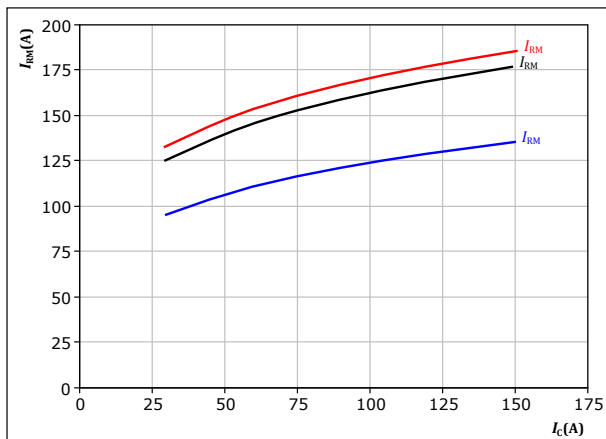
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 28.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

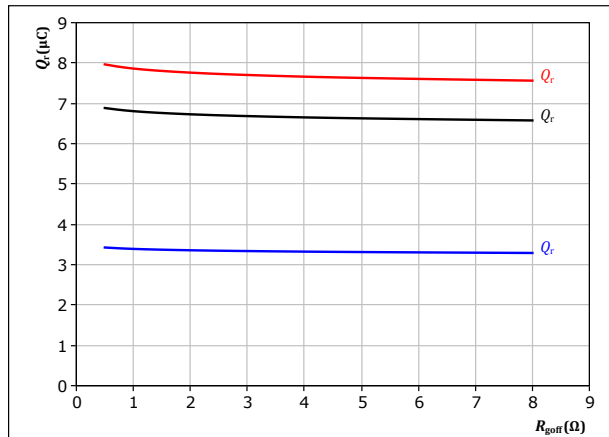
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 27.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_c = 90$ A

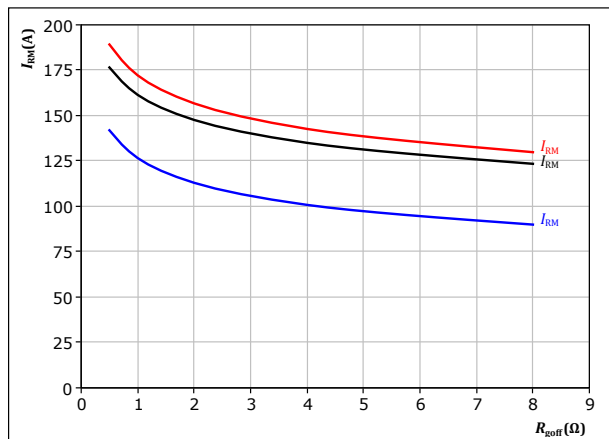
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 29.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_c = 90$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



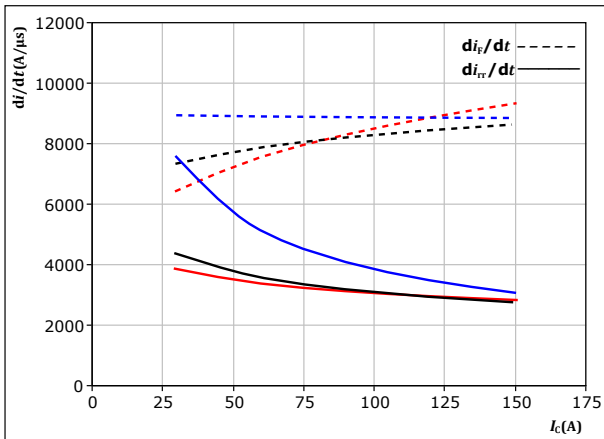
Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Buck Switching Characteristics

figure 30. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

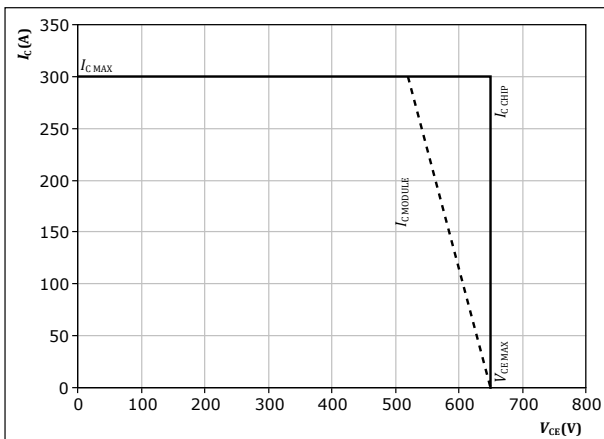
$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{goff} = 2$ Ω

$T_j = 25$ °C
 125 °C
 150 °C

figure 31. FWD

Reverse bias safe operating area

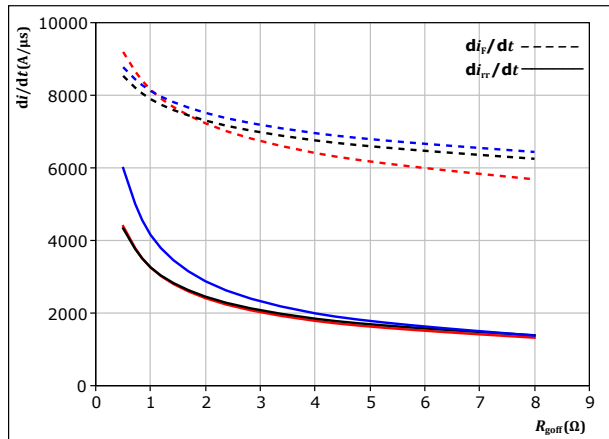
$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{goff} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

$T_j = 25$ °C
 125 °C
 150 °C



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

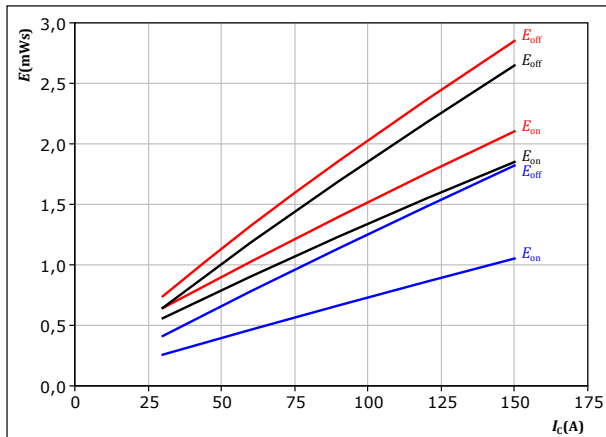
Boost Switching Characteristics

figure 33.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

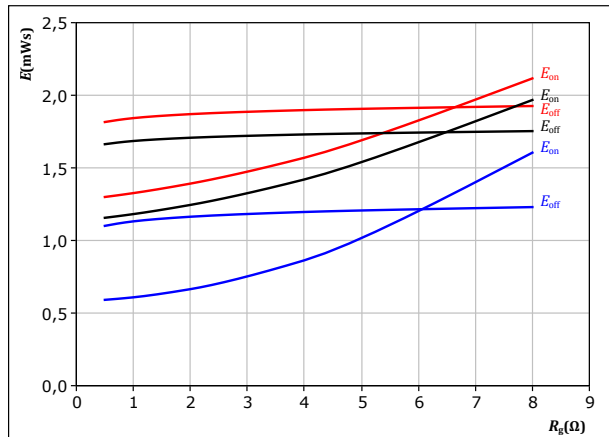
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 34.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

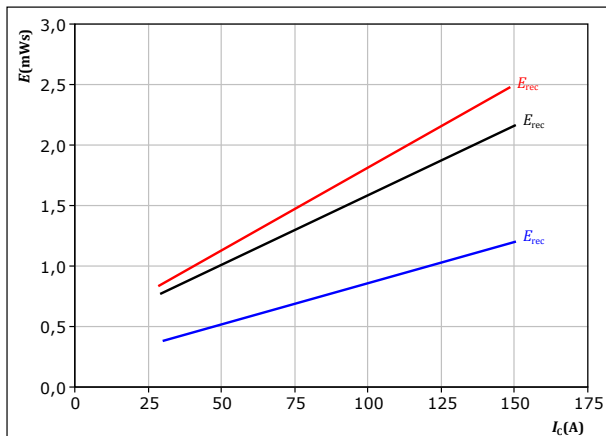
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 35.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

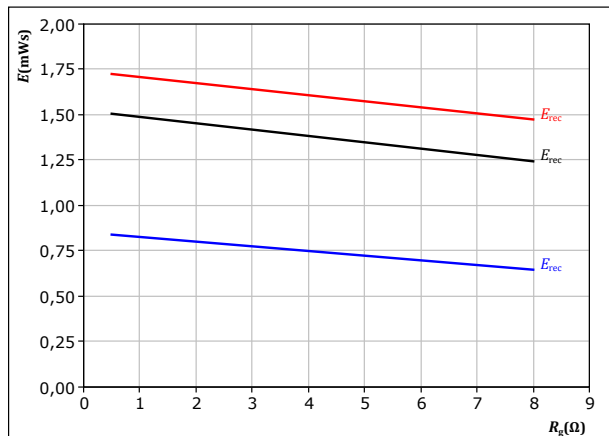
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 36.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

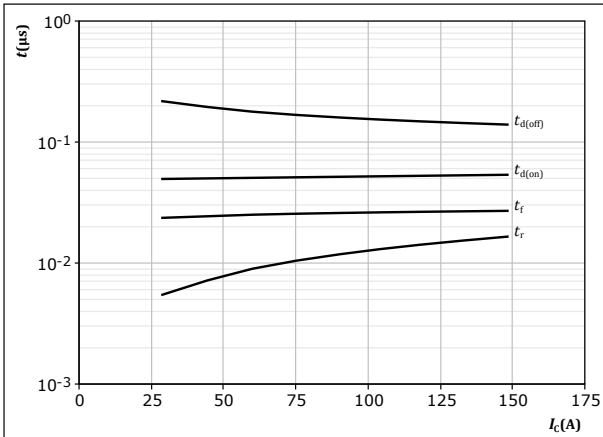
10-PY07NIA150S504-L365F54Y
datasheet

Boost Switching Characteristics

figure 37.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



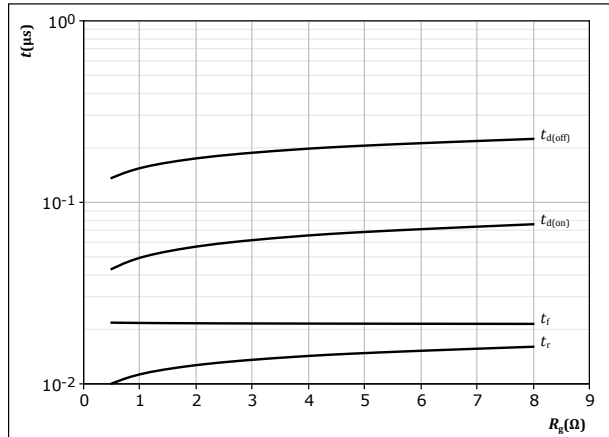
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 38.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$



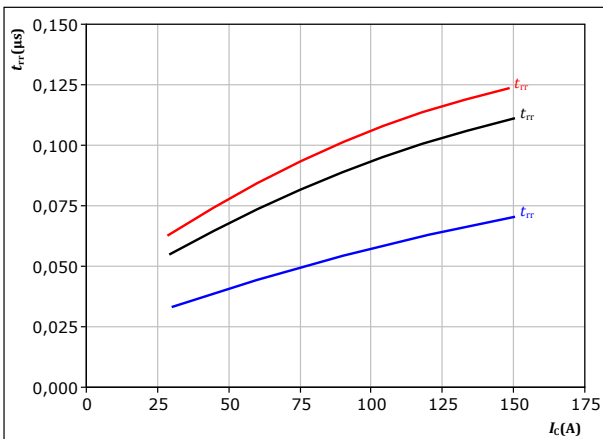
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

figure 39.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

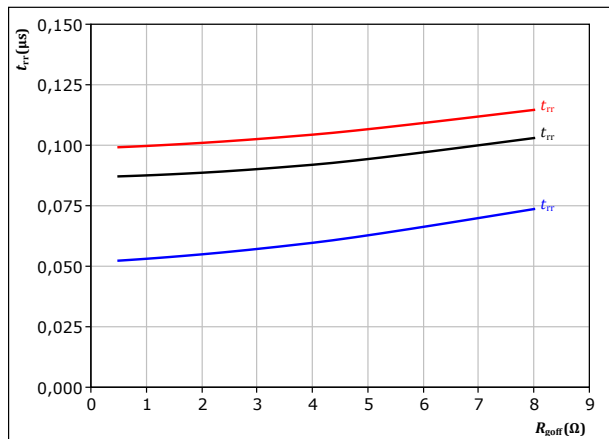
$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

T_j : — 25 °C
— 125 °C
— 150 °C

figure 40.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

T_j : — 25 °C
— 125 °C
— 150 °C



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

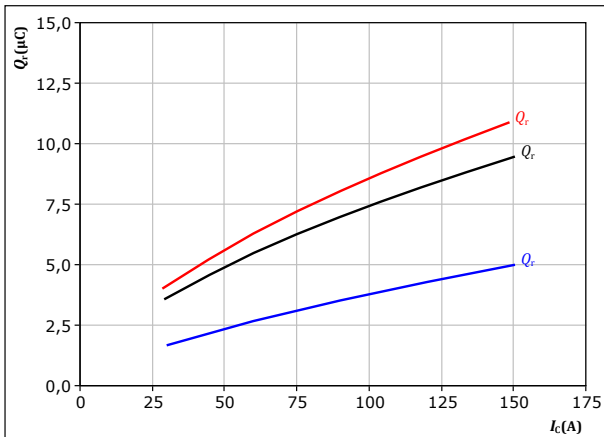
Boost Switching Characteristics

figure 41.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

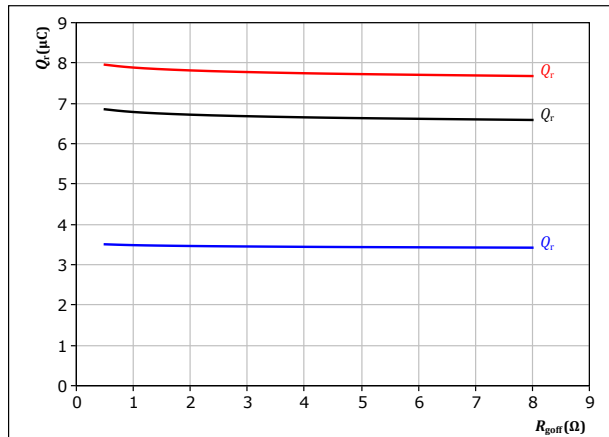
T_j : 25 °C
125 °C
150 °C

figure 42.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_c = 90$ A

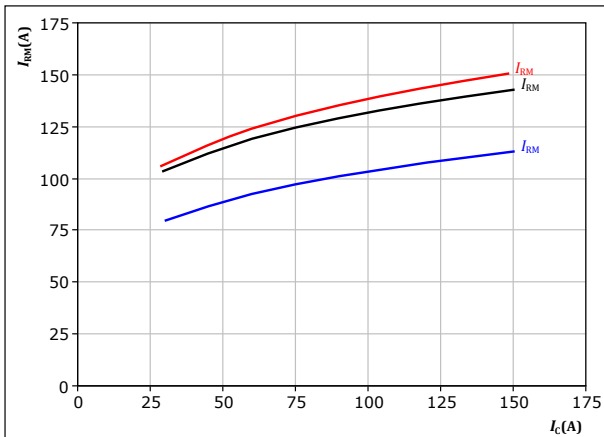
T_j : 25 °C
125 °C
150 °C

figure 43.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

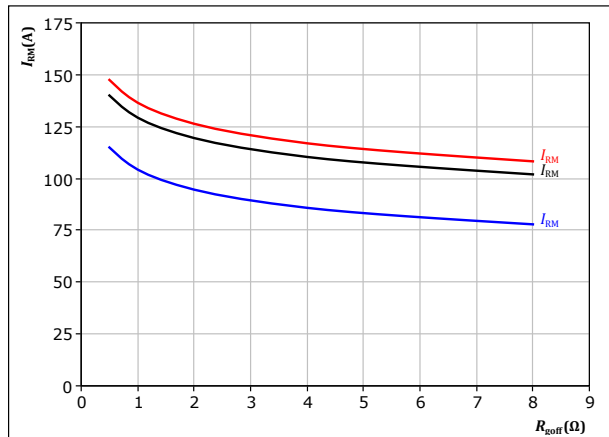
T_j : 25 °C
125 °C
150 °C

figure 44.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_c = 90$ A

T_j : 25 °C
125 °C
150 °C



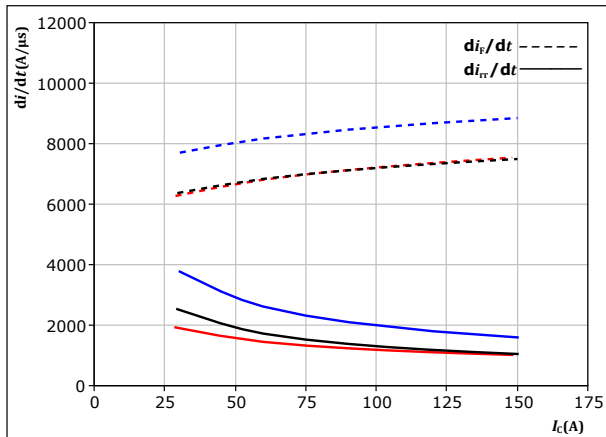
Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Boost Switching Characteristics

figure 45. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



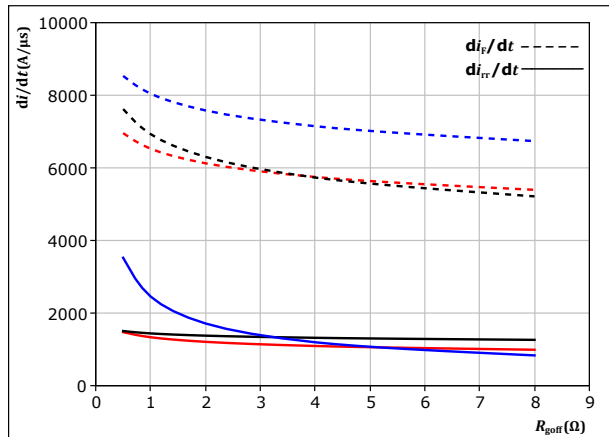
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $R_{gon} = 2$ Ω

$T_j = 25$ °C
125 °C
150 °C

figure 46. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

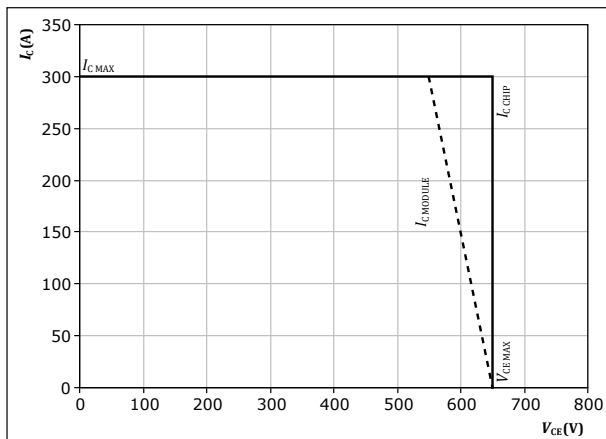
$V_{CE} = 350$ V
 $V_{GE} = -5/15$ V
 $I_C = 90$ A

$T_j = 25$ °C
125 °C
150 °C

figure 47. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω



Vincotech

Switching Definitions

figure 48. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

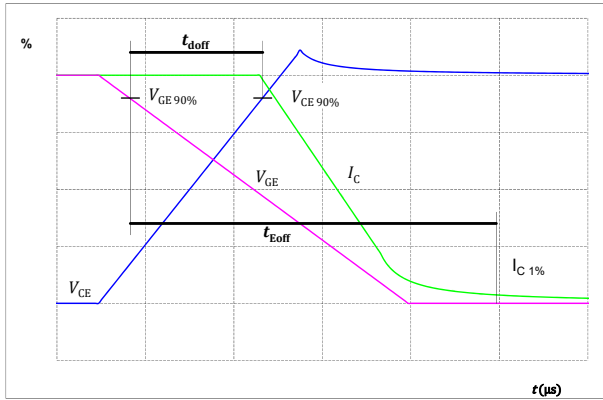


figure 49. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

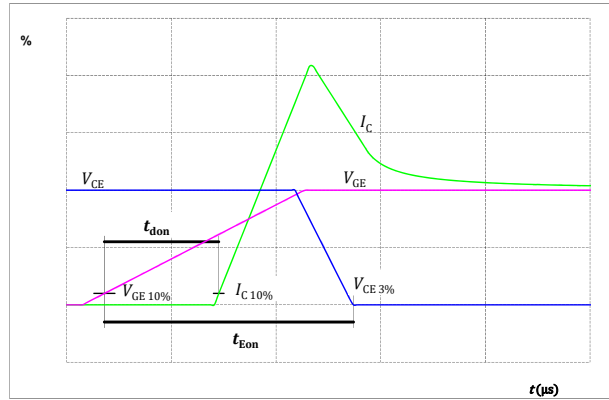


figure 50. IGBT

Turn-off Switching Waveforms & definition of t_f

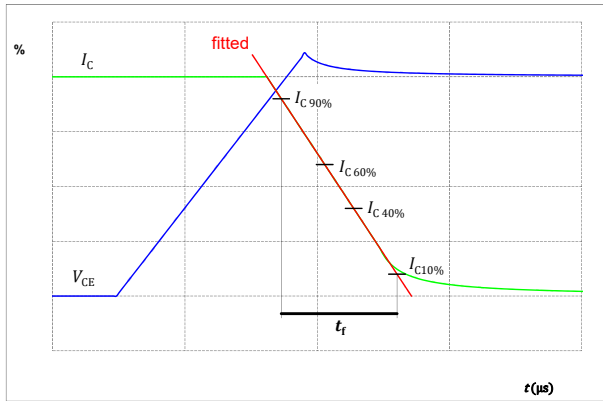
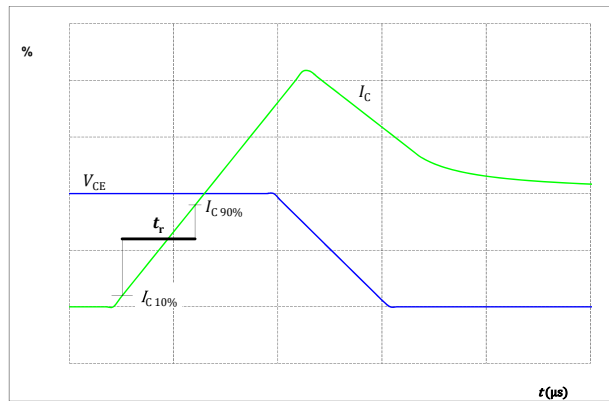


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_r





Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

Switching Definitions

figure 52.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

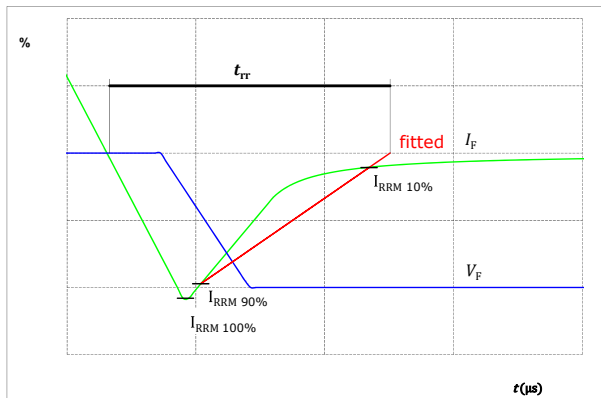
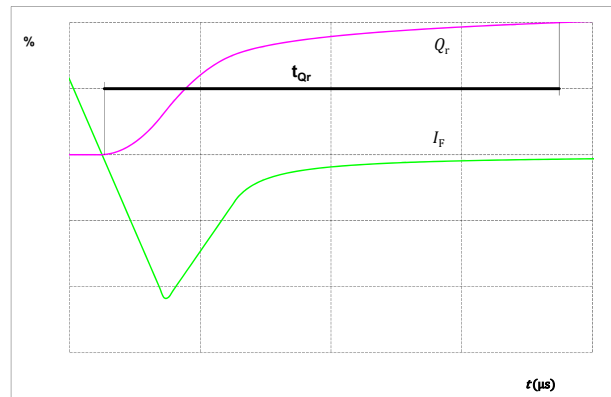


figure 53.

FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





datasheet

| Ordering Code | |
|--|--------------------------------|
| Version | Ordering Code |
| Without thermal paste | 10-PY07NIA150S504-L365F54Y |
| With thermal paste (5,2 W/mK, PTM6000HV) | 10-PY07NIA150S504-L365F54Y-/7/ |
| With thermal paste (3,4 W/mK, PSX-P7) | 10-PY07NIA150S504-L365F54Y-/3/ |

| Marking | | | | | | | |
|---|------------|-------------------------------|------------|-----------|-----------|-------|--------|
|  | Text | Name | | Date code | UL & VIN | Lot | Serial |
| | | NN-NNNNNNNNNNNNNN- TTTTTVV | | WWYY | UL VIN | LLLLL | SSSS |
| | Datamatrix | Type&Ver | Lot number | Serial | Date code | | |
| | TTTTTVV | LLLLL | SSSS | WWYY | | | |

Outline

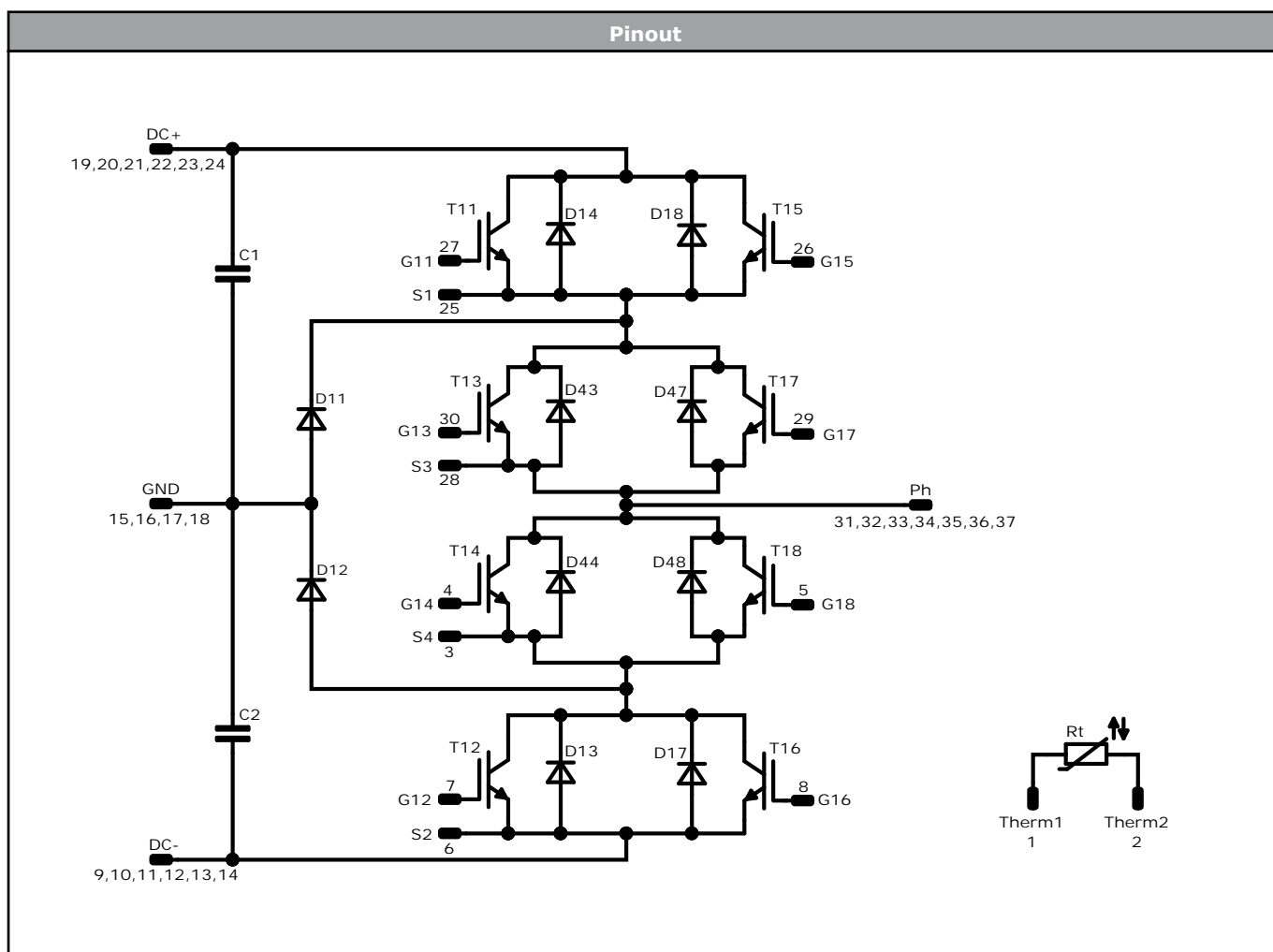
| Pin table [mm] | | | |
|----------------|------|-------|----------|
| Pin | X | Y | Function |
| 1 | 52,2 | 6,9 | Therm1 |
| 2 | 52,2 | 0 | Therm2 |
| 3 | 36,2 | 6,75 | S4 |
| 4 | 33,2 | 7,9 | G14 |
| 5 | 33,2 | 4,9 | G18 |
| 6 | 9,2 | 5,75 | S2 |
| 7 | 6,2 | 6,9 | G12 |
| 8 | 6,2 | 3,9 | G16 |
| 9 | 2,7 | 0 | DC- |
| 10 | 0 | 0 | DC- |
| 11 | 2,7 | 2,7 | DC- |
| 12 | 0 | 2,7 | DC- |
| 13 | 2,7 | 5,4 | DC- |
| 14 | 0 | 5,4 | DC- |
| 15 | 2,7 | 12,75 | GND |
| 16 | 0 | 12,75 | GND |
| 17 | 2,7 | 15,45 | GND |
| 18 | 0 | 15,45 | GND |
| 19 | 2,7 | 22,8 | DC+ |
| 20 | 0 | 22,8 | DC+ |
| 21 | 2,7 | 25,5 | DC+ |
| 22 | 0 | 25,5 | DC+ |
| 23 | 2,7 | 28,2 | DC+ |
| 24 | 0 | 28,2 | DC+ |
| 25 | 18,3 | 22,45 | S1 |
| 26 | 21,3 | 21,3 | G15 |
| 27 | 21,3 | 24,3 | G11 |
| 28 | 43 | 22,15 | S3 |
| 29 | 46 | 21 | G17 |
| 30 | 46 | 24 | G13 |
| 31 | 52,2 | 20,1 | Ph |
| 32 | 49,5 | 22,8 | Ph |
| 33 | 52,2 | 22,8 | Ph |
| 34 | 49,5 | 25,5 | Ph |
| 35 | 52,2 | 25,5 | Ph |
| 36 | 49,5 | 28,2 | Ph |
| 37 | 52,2 | 28,2 | Ph |

Tolerance of pinpositions: $\pm 0.5\text{mm}$ at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet




| Identification | | | | | |
|--------------------|------------|---------|---------|----------------------|--|
| ID | Component | Voltage | Current | Function | Comment |
| T11, T15, T12, T16 | IGBT | 650 V | 150 A | Buck Switch | Parallel devices with separate control. Values apply to complete device. |
| D11, D12 | FWD | 650 V | 150 A | Buck Diode | |
| T13, T17, T14, T18 | IGBT | 650 V | 150 A | Boost Switch | Parallel devices with separate control. Values apply to complete device. |
| D13, D17, D14, D18 | FWD | 650 V | 150 A | Boost Diode | |
| D44, D48, D43, D47 | FWD | 650 V | 150 A | Boost Sw. Inv. Diode | |
| C1, C2 | Capacitor | 630 V | | Capacitor (DC) | |
| Rt | Thermistor | | | Thermistor | |



Vincotech

10-PY07NIA150S504-L365F54Y
datasheet

| Packaging instruction | | | | |
|---|------|----------|------|---|
| Standard packaging quantity (SPQ) 100 | >SPQ | Standard | <SPQ | Sample |
| Handling instruction | | | | |
| Handling instructions for <i>flow</i> 1 packages see vincotech.com website. | | | | |
| Package data | | | | |
| Package data for <i>flow</i> 1 packages see vincotech.com website. | | | | |
| Vincotech thermistor reference | | | | |
| See Vincotech thermistor reference table at vincotech.com website. | | | | |
| UL recognition and file number | | | | |
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. | | | |  |

| Document No.: | Date: | Modification: | Pages |
|----------------------------------|--------------|--|-------|
| 10-PY07NIA150S504-L365F54Y-D2-14 | 27 Sep. 2021 | New Datasheet format, module is unchanged Correct Thermal values of Boost Sw. Inv. Diode Correct Clearance value | |

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.